AMMP-6425 18-28 GHz 1W Power Amplifier in SMT Package

Data Sheet





Description

The AMMP-6425 MMIC is a broadband 1W power amplifier in a surface mount package designed for use in transmitters that operate in various frequency bands between 18GHz and 28GHz. At 25GHz, it provides 31dBm of output power (P-1dB) and 25dB of small-signal gain from a small easy-to-use device. The device has input and output matching circuitry for use in 50 Ω environments. The AMMP-6425 also integrates a temperature compensated RF power detection circuit that enables power detection of 0.25V/W. DC bias is simple and the device operates on widely available 5V for current supply (negative voltage only needed for Vg). It is fabricated in a PHEMT process for exceptional power and gain performance.

Package Diagram



Note:

1. This MMIC uses depletion mode pHEMT devices. Negative supply is used for DC gate biasing.

Features

- 5x5 mm Surface Mount Package
- Wide Frequency Range 18-28GHz
- One watt output power
- 50Ω match on input and output

Specifications (Vd=5V, Idq=650mA)

- Frequency range 18 to 28 GHz
- Small signal Gain of 22dB
- Output power @P-1 of 28dBm (Typ.)
- Input/Output return-loss of -12dB

Applications

- Microwave Radio systems
- Satellite VSAT, DBS Up/Down Link
- LMDS & Pt-Pt mmW Long Haul
- Broadband Wireless Access (including 802.16 and 802.20 WiMax)
- WLL and MMDS loops
- Commercial grade military

Functional Block Diagram





Attention: Observe Precautions for handling electrostatic sensitive devices. ESD Machine Model (Class A): 60V ESD Human Body Model (Class 0): 200V Refer to Avago Application Note A004R: Electrostatic Discharge Damage and Control.

Note: MSL Rating = Level 2A

Electrical Specifications

- 1. Small/Large -signal data measured in a fully de-embedded test fixture form TA = 25°C.
- 2. Pre-assembly into package performance verified 100% on-wafer per AMMC-6425 published specifications.
- 3. This final package part performance is verified by a functional test correlated to actual performance at one or more frequencies.
- 4. Specifications are derived from measurements in a 50 Ω test environment. Aspects of the amplifier performance may be improved over a more narrow bandwidth by application of additional conjugate, linearity, or low noise (Fopt) matching.
- 5. The Gain and P1dB tested at 18, 23 and 28 GHz guaranteed with measurement accuracy +/-1.5dB for Gain and P1dB, except Gain at 18 GHz with measurement accuracy +/-1.8dB.

Table 1. RF Electrical Characteristics

TA=25°C, Vd=5.0V, Idq=650mA, Vg=-1.1V, Zo=50 Ω

| | 18GH: | z | | 23GH | z | | 28GH | z | | | |
|---|-------|-----|-----|------|-----|-----|------|-----|-----|------|---------|
| Parameter | Min | Тур | Мах | Min | Тур | Мах | Min | Тур | Мах | Unit | Comment |
| Operational Frequency | 18 | | 28 | 18 | | 28 | 18 | | 28 | GHz | |
| Small Signal Gain, Gain | 21 | 23 | | 21 | 23 | | 20 | 22 | | dB | |
| Output Power at 1dBGain Compression, P1dB | 26 | 28 | | 27 | 28 | | 27 | 28 | | dBm | |
| Output Third Order Intercept Point, OIP3 | | 35 | | | 35 | | | 35 | | dBm | |
| Reverse Isolation, Isolation | | 43 | | | 43 | | | 43 | | dB | |
| Input Return Loss, RLin | | 10 | | | 10 | | | 10 | | dB | |
| Output Return Loss, RLout | | 10 | | | 10 | | | 10 | | dB | |

Table 2. Recommended Operating Range

- 1. Ambient operational temperature $TA = 25^{\circ}C$ unless otherwise noted.
- 2. Channel-to-backside Thermal Resistance (Tchannel (Tch) = 34°C) as measured using infrared microscopy. Thermal Resistance at backside temperature (Tb) = 25°C calculated from measured data.

| Description | Min. | Typical | Max. | Unit | Comments |
|---------------------------|------|---------|------|------|---|
| Drain Supply Current, Idq | | 650 | | mA | Vd = 5V, Vg set for typical Idq Typical |
| Gate Supply Voltage, Vg | | -1.1 | | V | ldq = 650mA |

Table 3. Thermal Properties

| Parameter | Test Conditions | Value |
|---|---|--|
| Thermal Resistance (Channel-to-Base Plate), Rθch-b | | Rθch-b= 17.8°C/W |
| Channel temperature, Tch | | Tch =142.8°C |
| Maximum Power Dissipation | Tbaseplate = 85°C | |
| Thermal Resistance (channel to backside), θjc | Vd = 5V Id = 650mA $P_D = 3.25W$ Tbaseplate = 85°C | θjc = 17.8 °C/W Tch = 143 °C Pd = 410 Tch = 143°C |
| Channel Temperature, Tch | Vd = 5V Id = 900mA Pout = 30dBm Pd = 3.5W Tbaseplate = 85°C | θjc = 17.8 °C/W Tch = 147 °C |

Note:

Assume SnPb soldering to an evaluation RF board at 85°C base plate temperatures. Worst case is at saturated output power when DC power consumption rises to 5.5W with 1.58W RF power delivered to load. Power dissipation is 3.92W and the temperature rise in the channel is 69.8°C. In this condition, the channel temperature reached at the maximum operational channel temperature of 155°C. To maintain the maximum operational temperature below 155°C, the base plate temperature must be maintained below 85°C.

Absolute Minimum and Maximum Ratings

Table 4. Minimum and Maximum Ratings

| Description Pin | Min. | Max. | Unit | Comments |
|--|------|------|------|-------------------|
| Drain to Gate Voltage, Vd-Vg | | 8 | V | |
| Drain Supply Voltage, Vd | | 5.5 | V | |
| Gate Supply Voltage, Vg | -2.5 | 0.5 | V | |
| Power Dissipation, Pd ^[2,3] | | 4 | W | |
| RF CW Input Power, Pin ^[3] | | 20 | dBm | CW |
| Channel Temperature, Tch, max ^[4] | | +150 | °C | |
| Storage Case Temperature, Tstg | -65 | +155 | °C | |
| Maximum Assembly Temperature, Tmax | | 320 | °C | 30 second maximum |

Notes:

1. Operation in excess of any one of these conditions may result in permanent damage to this device.

2. Dissipated power PD is in any combination of DC voltage, Drain Current, input power and power delivered to the load.

3. When operated at maximum PD with a base plate temperature of 85 C, the median time to failure (MTTF) is significantly reduced.

4. These ratings apply to each individual FET. The operating channel temperature will directly affect the device MTTF. For maximum life, it is recommended that junction temperatures (Tj) be maintained at the lowest possible levels. See MTTF vs. Tchannel Temperature Table.

AMMP-6425 Typical Performance

(Data obtained from 2.4-mm connector based test fixture, and this data is including connecter loss, and board loss.) ($T_A = 25^{\circ}C$, Vd=5V, Idq=650mA, $V_g=-1.1 V$, $Z_{in} = Z_{out} = 50\Omega$)





Figure 1. Typical Gain and Reverse Isolation



Figure 3. Typical P-1 and PAE



Figure 5. Typical IP3 (Third Order Intercept) @Pin=-20dBm

Figure 2. Typical Input & Output Return Loss







Figure 6. Typical Noise Figure



Figure 7. Typical Detector voltage vs. Output Power



Figure 9. Typical S11 over temperature



Figure 11. Typical Gain over temperature



Figure 8. Typical S22 over temperature



Figure 10. Typical P-1 over temperature

Typical Scattering Parameters ^[1] ($T_A = 25^{\circ}C$, $V_d = 5$ V, $I_{dq} = 650$ mA, $Z_{in} = Z_{out} = 50\Omega$)

| req | S11 | | | S21 | | | S12 | | | S22 | | |
|--------|--------------------|----------------|--------------------|--------------------|----------------|---------------------|--------------------|----------------------|--------------------|------------------|----------------|--------------------|
| GHz] | dB | Mag | Phase | dB | Mag | Phase | dB | Mag | Phase | dB | Mag | Phase |
| | -0.178 | 0.980 | -37.820 | -47.292 | 0.004 | -74.488 | -80.369 | 9.58E-05 | 103.780 | -0.085 | 0.990 | -34.276 |
| | -0.523 | 0.942 | -74.503 | -44.008 | 0.006 | 149.890 | -70.925 | 2.84E-04 | 15.146 | -0.279 | 0.968 | -68.410 |
| | -0.978 | 0.893 | -110.430 | -46.417 | 0.005 | 67.301 | -65.116 | 5.55E-04 | -50.709 | -0.630 | 0.930 | -102.40 |
| | -1.451 | 0.846 | -145.650 | -46.503 | 0.005 | 13.513 | -62.769 | 7.27E-04 | -62.503 | -1.318 | 0.859 | -134.93 |
| | -2.031 | 0.792 | 178.840 | -45.038 | 0.006 | -58.861 | -58.964 | 1.13E-03 | -135.670 | -1.389 | 0.852 | -167.44 |
| | -2.704 | 0.732 | 143.950 | -47.901 | 0.004 | -154.120 | -54.809 | 1.82E-03 | 178.760 | -1.958 | 0.798 | 158.670 |
| | -3.392 | 0.677 | 109.310 | -49.517 | 0.003 | 169.350 | -53.665 | 2.07E-03 | 141.890 | -2.558 | 0.745 | 125.480 |
| | -4.109 | 0.623 | 75.156 | -50.018 | 0.003 | 105.240 | -51.070 | 2.80E-03 | 104.940 | -3.104 | 0.700 | 92.207 |
| ~ | -4.791 | 0.576 | 41.436 | -53.613 | 0.002 | 44.075 | -51.693 | 2.60E-03 | 53.998 | -3.633 | 0.658 | 58.406 |
| 0 | -5.516 | 0.530 | 8.579 | -56.475 | 0.002 | -12.575 | -51.331 | 2.71E-03 | 32.567 | -4.100 | 0.624 | 24.394 |
| 1 2 | -6.364 -7.445 | 0.481 0.424 | -23.142 -52.655 | -46.029 -29.971 | 0.005 0.032 | -103.650 | -51.167 | 2.76E-03 2.63E-03 | 11.953 3.625 | -4.608 | 0.588 | -10.323 -45.888 |
| 2 | -8.819 | 0.424 | -78.361 | -16.053 | 0.052 | -152.130 149.700 | -51.615 -50.249 | 2.03E-03 3.07E-03 | -15.675 | -5.224 -6.438 | 0.548 0.477 | -43.888 |
| 4 | -10.363 | 0.302 | -98.427 | -3.496 | 0.669 | 81.099 | -50.249 | 3.07E-03 | -28.191 | -0.438 | 0.353 | -120.89 |
| 5 | -11.090 | 0.279 | -112.740 | 8.685 | 2.718 | -4.135 | -46.066 | 4.97E-03 | -65.232 | -14.588 | 0.186 | -150.36 |
| 6 | -12.282 | 0.243 | -131.170 | 18.694 | 8.604 | -119.950 | -46.237 | 4.88E-03 | -110.450 | -24.953 | 0.057 | -82.936 |
| 7 | -12.416 | 0.239 | -151.110 | 22.143 | 12.798 | 128.380 | -60.278 | 9.68E-04 | -136.210 | -14.586 | 0.187 | -124.06 |
| 8 | -18.133 | 0.124 | -159.160 | 25.421 | 18.666 | 25.746 | -58.209 | 1.23E-03 | -69.871 | -17.548 | 0.133 | -113.80 |
| 9 | -11.405 | 0.269 | -143.530 | 24.729 | 17.236 | -77.696 | -47.566 | 4.18E-03 | -85.440 | -9.908 | 0.320 | -139.56 |
| 0 | -12.614 | 0.234 | 172.380 | 25.037 | 17.859 | -153.820 | -45.013 | 5.61E-03 | -114.600 | -12.434 | 0.239 | 164.360 |
| 21 | -15.765 | 0.163 | 172.820 | 25.244 | 18.289 | 120.010 | -46.939 | 4.50E-03 | -153.480 | -19.545 | 0.105 | 177.54 |
| 2 | -18.729 | 0.116 | 169.430 | 25.205 | 18.208 | 41.393 | -46.250 | 4.87E-03 | -155.050 | -19.073 | 0.111 | -162.42 |
| .3 | -19.222 | 0.109 | 155.900 | 24.889 | 17.557 | -34.617 | -49.429 | 3.38E-03 | 165.260 | -19.220 | 0.109 | 176.78 |
| .4 | -16.511 | 0.149 | 168.470 | 23.841 | 15.562 | -111.460 | -47.594 | 4.17E-03 | 177.280 | -17.045 | 0.141 | -178.55 |
| 25 | -18.712 | 0.116 | 146.270 | 23.888 | 15.647 | -179.450 | -46.045 | 4.99E-03 | 168.010 | -18.114 | 0.124 | 171.490 |
| 6 | -17.947 | 0.127 | 175.590 | 24.682 | 17.143 | 103.360 | -45.724 | 5.17E-03 | 158.550 | -16.455 | 0.150 | -178.83 |
| 7 | -11.711 | 0.260 | 168.100 | 24.823 | 17.423 | 13.068 | -42.460 | 7.53E-03 | 135.940 | -11.479 | 0.267 | 172.720 |
| 8 | -10.060 | 0.314 | 125.410 | 22.405 | 13.191 | -74.382 | -41.090 | 8.82E-03 | 113.320 | -11.025 | 0.281 | 129.980 |
| 9 | -13.299 | 0.216 | 95.693 | 19.705 | 9.666 | -157.160 | -42.711 | 7.32E-03 | 83.227 | -15.117 | 0.175 | 123.360 |
| 0 | -17.064 | 0.140 | 102.470 | 16.154 | 6.422 | 122.330 | -38.921 | 1.13E-02 | 55.944 | -13.896 | 0.202 | 133.650 |
| 1 | -13.487 | 0.212 | 101.410 | 12.154 | 4.052 | 48.186 | -44.057 | 6.27E-03 | | -11.050 | | 111.830 |
| 2 | -11.785 | 0.257 | 84.008 | 8.383 | 2.625 | -23.332 | -46.564 | | 2.928 | -10.645 | 0.294 | 91.607 |
| 3 | -11.532 | 0.265 | 62.490 | 4.076 | 1.599 | -91.933 | -53.813 | 2.04E-03 | 17.837 | -10.575 | 0.296 | 76.604 |
| 4 | -10.906 | 0.285 | 45.088 | 0.130 | 1.015 | -158.780 | -55.014 | 1.78E-03 | 112.070 | -10.010 | 0.316 | 61.871 |
| 85 | -10.536 | 0.297 | 23.915 | -4.190 | 0.617 | 136.430 | -48.002 | 3.98E-03 | 132.840 | -9.589 | 0.332 | 45.962 |
| 6 | -10.699 | 0.292 | -1.693 | -8.418 | 0.379 | 74.411 | -40.193 | 9.78E-03 | 80.387 | -9.107 | 0.350 | 29.444 |
| 7 8 | -12.367 | 0.241 | -29.330 | -12.489 | 0.237 | 15.586 | -38.833 | | 35.254 | -8.758 | 0.365 | 12.764 |
| | -17.928 | 0.127 | -55.180 | -16.801 | 0.145 | -41.207 | -37.437 | 1.34E-02 | | -8.550 8.006 | 0.374 | -1.575 |
| 9 0 | -23.162 -11.353 | 0.069 | 34.718 26 590 | -21.962 | 0.080 0.041 | -95.210 -155 570 | -34.527 | 1.88E-02 | | -8.096 -7.734 | 0.394 | -17.493 |
| 1 | -7.080 | 0.271 0.443 | 26.590 -9.207 | -27.653 -40.696 | 0.041 | -155.570 131.530 | -36.493 -36.464 | 1.50E-02 1.50E-02 | | -7.734 -7.456 | 0.410 0.424 | -32.201 -46.161 |
| 2 | -5.965 | 0.445 | -9.207 -39.140 | -40.696 | 0.009 | -26.815 | -36.404 -36.100 | 1.50E-02 1.57E-02 | -65.002 -66.924 | -7.450 | 0.424 | -40.101 |
| 3 | -6.061 | 0.303 | -62.125 | -33.829 | 0.013 | -89.274 | -34.607 | 1.86E-02 | | -6.790 | 0.447 | -74.546 |
| 4 | -6.152 | 0.498 | -76.987 | -32.808 | 0.020 | -126.740 | -33.593 | 2.09E-02 | -126.260 | -6.710 | 0.458 | -87.216 |
| -5 | -5.936 | 0.492 | -89.697 | -36.302 | 0.025 | -161.820 | 55.555 | 1.33E-02 | 120.200 | 0.710 | 0.461 | -98.984 |

Note:

1. Data obtained from a 2.4-mm connecter based module, and this data is including connecter loss, and board loss.

AMMP-6425 Biasing and Operation

Recommended quiescent DC bias condition for optimum power and linearity performances is Vd=5 volts with Vg (-1.1V) set for Idq=650 mA. Minor improvements in performance are possible depending on the application. The drain bias voltage range is 3 to 5V. A single DC gate supply connected to Vg will bias all gain stages. Muting can be accomplished by setting Vgg to the pinch-off voltage Vp.

A simplified schematic for the AMMP6425 MMIC die is shown in Figure 12. The MMIC die contains ESD and over voltage protection diodes for Vg, and Vdd terminals. The package diagram for the recommended assembly is shown in Figure 13. In finalized package form, ESD diodes protect all possible ESD or over voltage damages between Vg and ground, Vg and Vd, Vd and ground. Typical ESD diode current versus diode voltage for 11connected diodes in series is shown in Figure 14. Under the recommended DC guiescent biasing condition at Vds=5V, Ids=650mA, Vg=-1V, typical gate terminal current is approximately 0.3mA. If an active biasing technique is selected for the AMMP6425 MMIC PA DC biasing, the active biasing circuit must have more than 10-times higher internal current that the gate terminal current.

An optional output power detector network is also provided. The differential voltage between the Det-Ref and Det-Out pads can be correlated with the RF power emerging from the RF output port. The detected voltage is given by :

$$V = (V_{ref} - V_{det}) - V_{ofs}$$

where V_{ref} is the voltage at the DET_R port, V_{det} is a voltage at the DET_0 port, V_{ofs} and is the zero-input-power offset voltage.

There are three methods to calculate Vofs :

- 1. V_{ofs} can be measured before each detector measurement (by removing or switching off the power source and measuring V_{ref} - V_{det}). This method gives an error due to temperature drift of less than 0.01dB/50°C.
- 2. V_{ofs} can be measured at a single reference temperature. The drift error will be less than 0.25dB.
- 3. V_{ofs} can either be characterized over temperature and stored in a lookup table, or it can be measured at two temperatures and a linear fit used to calculate V_{ofs} at any temperature. This method gives an error close to the method #1.

The RF ports are AC coupled at the RF input to the first stage and the RF output of the final stage. No ground wired are needed since ground connections are made with plated through-holes to the backside of the device.



Figure 12. Simplified schematic for the MMIC die



| Pin | Function |
|-----|----------|
| 1 | Vg |
| 2 | Vd |
| 3 | DET_O |
| 4 | RF_out |
| 5 | DET_R |
| 6 | Vd |
| 7 | Vg |
| 8 | RF_in |

Figure 13. Typical DC connection



Figure 14. Typical ESD diode current versus diode voltage for 11-connected diodes in series

Note:

No RF performance degradation is seen due to ESD up to 200V HBM and 60V MM. The DC characteristics in general show increased leakage at lower ESD discharge voltages. The user is reminded that this device is ESD sensitive and needs to be handled with all necessary ESD protocols.

Package Dimension, PCB Layout and Tape and Reel information

Please refer to Avago Technologies Application Note 5520, AMxP-xxxx production Assembly Process (Land Pattern A).

| Part Number | Devices Per Container | Container | | |
|----------------|--------------------------|----------------|--|--|
| AMMP-6425-BLKG | 10 | Antistatic bag | | |
| AMMP-6425-TR1G | 100 | 7" Reel | | |
| AMMP-6425-TR2G | 500 | 7" Reel | | |

AMMP-6425 Part Number Ordering Information

For product information and a complete list of distributors, please go to our web site: www.avagotech.com

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